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PATENT

Paper No. 3

Date: January 9, 2001

By:   
(Signature of person mailing paper or fee)

File No. Concir-2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventors	:	Brian J. McDermott, Jr., Daniel McGowan, Ralph Leo Spotts, and Sid Tryzbiak
Serial No.	:	09/694,099
Filed	:	October 10, 2000
For	:	IMPROVED CIRCUIT BOARD OR OTHER MULTILAYER ELECTRICAL DEVICE MADE BY FORMING TEETH TO JOIN LAYERS
Group Art Unit	:	3729
Examiner	:	

The Commissioner of Patents and Trademark  
Washington, D.C. 20231

**REQUEST FOR CORRECTED FILING RECEIPT**


SIR:

In the above-referenced patent application, please issue a corrected filing receipt to show the title of the invention as "IMPROVED CIRCUIT BOARD OR OTHER MULTILAYER ELECTRICAL DEVICE MADE BY FORMING TEETH TO JOIN LAYERS" and not "Circuit Board Or Other Multilayer Electrical Device Made By Forming Teeth To Join Layers".

The Commissioner is hereby authorized to charge any fees associated with the above-identified patent application or credit any overcharges to Deposit Account No. 50-0235.

Please direct all correspondence to the undersigned at the address given below.

Respectfully submitted,

  
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Date: January 9, 2001

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## UNITED STATES PATENT AND TRADEMARK OFFICE

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WASHINGTON, D.C. 20231  
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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/694,099	10/20/2000	3729	0	ContCir-2	2	19	1

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## FILING RECEIPT



\*OC000000005627658\*

Date Mailed: 12/19/2000

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

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## Continuing Data as Claimed by Applicant

THIS APPLICATION IS A CON OF 08/905,619 08/04/1997 PAT 6,141,870

## Foreign Applications

If Required, Foreign Filing License Granted 12/15/2000

## Title

Improved  
Circuit board or other multilayer electrical device made by forming teeth to join layers

## Preliminary Class

029

Data entry by : GEBRESILASSIE, FREWOINI Team : OIPE

Date: 12/19/2000

